

Title (en)
INPUT DEVICE MANUFACTURE

Title (de)
HERSTELLUNG EINER EINGABEVORRICHTUNG

Title (fr)
FABRICATION DE DISPOSITIF D'ENTRÉE

Publication
EP 2849861 A4 20160413 (EN)

Application
EP 13728568 A 20130514

Priority
• US 201261647405 P 20120515
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• US 2013041017 W 20130514

Abstract (en)
[origin: WO2013173385A2] Input device manufacture techniques are described. In one or more implementations, a plurality of layers of a key assembly is positioned in a fixture such that one or more projections of the fixture are disposed through one or more openings in each of the one or more layers. The positioned plurality of layers is secured to each other.

IPC 8 full level
A63F 13/00 (2014.01); **G06F 1/16** (2006.01); **G06F 3/02** (2006.01); **H01H 13/702** (2006.01)

CPC (source: CN EP US)
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Citation (search report)
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• [X] DE 10116556 A1 20021010 - SIEMENS AG [DE]
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• See references of WO 2013173385A2

Designated contracting state (EPC)
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DOCDB simple family (publication)
WO 2013173385 A2 20131121; **WO 2013173385 A3 20140912**; CN 104272221 A 20150107; CN 104272221 B 20180302; EP 2849861 A2 20150325; EP 2849861 A4 20160413; JP 2015517708 A 20150622; KR 20150013439 A 20150205

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